







ATTORNEY'S DOCKET NO.

APPLICATION FOR UNITED STATES PATENT DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor if only one name is listed below, or an original, first and joint inventor if plural inventors are named below, of the subject matter which is claimed and for which a patent is sought on the invention entitled as set forth below, which is described in the attached specification of Application Serial No. 10/086,117, filed 2/26/02; that I have reviewed and understand the contents of the specification, including the claims, as amended by any amendment specifically referred to in the oath or declaration; that no application for patent or inventor's certificate on this invention has been filed by me or my legal representatives or assigns in any country foreign to the United States of America; and that I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56;

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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	TITLE OF INVENTION:				
	. Pris on copper raus in integrated Circuits				
	APPLICATION AND TRANSACT ALL BUSINESS IN THE PATENT AND TRADEMARK OFFICE CONNECTED THEREWITH				
	SEND CORRESPONDENCE TO: Gary C. Honeycutt Texas Instruments Incorporates P.O. Box 655474, MS 3999 Dallas, TX 75265	d	DIRECT TELEPHONE CALLS TO: Gary C. Honeycutt (214) 939-8651		
	NAME OF INVENTOR: (1)	NAME OF INVENTOR: (2)	NAME OF INVENTOR: (3)		
-	Christo P. Bojkov	Phillip Coffman	Patricia B. Smith		
	RESIDENCE & POST OFFICE ADDRESS: 8605 Kendall Drive Plano, Texas 75025	RESIDENCE & POST OFFICE ADDRESS: 6406 Nueces Bay Drive Rowlett, Texas 75089	RESIDENCE & POST OFFICE ADDRESS: 6902 Glenview Lane Colleyville, Texas 76034		
	COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:		
-	United States SIGNATURE OF INVENTOR:	United States	United States		
, -	Cher. By har	* Philip R Coffman	SIGNATURE OF INVENTOR: * Catalica Sanith		
v I	B/26/02	DATE: x (3/26/02	DATE: 3/28/02		

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I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

TITLE OF INVENTION:			_	
Waferlevel Method fo	r Direct Bumping on Copper Pads			
APPLICATION CONNECTED T	I HEREBY APPOINT PRACTITIONERS AT CUSTOMER NUMBER 23494 TO PROSECUTE THIS APPLICATION AND TRANSACT ALL BUSINESS IN THE PATENT AND TRADEMARK OFFICE CONNECTED THEREWITH			
Gary C. Honeycutt Texas Instruments Incorporated P.O. Box 655474, MS 3999 Dallas, TX 75265		DIRECT TELEPHONE CALLS TO: Gary C. Honeycutt (214) 939-8651		
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COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:		
United States	United States			
SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:		
DATE:	DATE:	DATE:		